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Siliup Semiconductor

SP010N110GT8

100V N-Channel MOSFET

## Product Summary

$V_{(BR)DSS}$	$R_{DS(on)}TYP$	$I_D$
100V	110m $\Omega$ @10V	3A

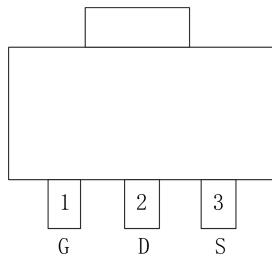
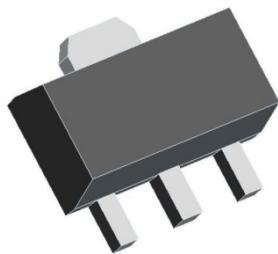
## Feature

- VDS 100V
- ID 3.0A
- $R_{DS(ON)}$ ( at  $VGS=10V$ ) < 140 mohm

## Applications

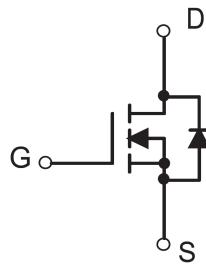
- Consumer electronic power supply
- Motor control
- Synchronous-rectification
- Isolated DC/DC convertor
- Invertors

## Package

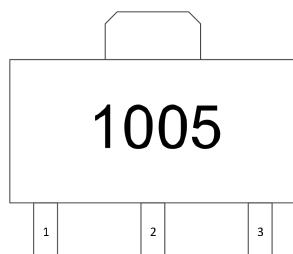


SOT-89-3L

## Circuit diagram



## Marking



1005 =Device Code



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**Absolute maximum ratings (Ta=25°C unless otherwise noted)**

Parameter	Symbol	Rating	Units
Drain-Source Voltage	V <sub>DS</sub>	100	V
Gate-Source Voltage	V <sub>GS</sub>	±20	V
Drain Current – Continuous	I <sub>D</sub>	3	A
Drain Current – Pulsed <sup>1</sup>	I <sub>DM</sub>	21	A
Power Dissipation (TC=25°C)	P <sub>D</sub>	2.6	W
Thermal Resistance Junction to ambient	R <sub>θJA</sub>	47.4	°C/W
Storage Temperature Range	T <sub>STG</sub>	-50 to 150	°C
Operating Junction Temperature Range	T <sub>J</sub>	-50 to 150	°C

**Electrical characteristics (Ta=25°C, unless otherwise noted)**

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
<b>Static Characteristics</b>						
Drain-Source Breakdown Voltage	B <sub>VDSS</sub>	V <sub>GS</sub> =0V , ID=250uA	100	110	---	V
Drain-Source Leakage Current	I <sub>DSS</sub>	V <sub>DS</sub> =100V , V <sub>GS</sub> =0V	---	---	1	uA
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>GS</sub> =V <sub>DS</sub> , ID = 250uA	1	1.8	3	V
Gate-Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V , V <sub>DS</sub> =0V	---	---	100	nA
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V , ID=3A	---	110	140	mΩ
		V <sub>GS</sub> =4.5V , ID=2A	---	160	300	mΩ
<b>Dynamic Characteristics</b>						
Total Gate Charge	Q <sub>g</sub>	V <sub>GS</sub> =10V,V <sub>DS</sub> =50V, ID=3.0A	---	4.3	---	nC
Gate-Source Charge	Q <sub>gs</sub>		---	1.5	---	
Gate-Drain Charge	Q <sub>gd</sub>		---	1.1	---	
Turn-On Delay Time	T <sub>d(on)</sub>	V <sub>GS</sub> =10V,V <sub>DD</sub> =50V, ID=3.0A, R <sub>GEN</sub> =2Ω	---	14.7	---	ns
Rise Time	T <sub>r</sub>		---	3.5	---	
Turn-Off Delay Time	T <sub>d(off)</sub>		---	20.9	---	
Fall Time	T <sub>f</sub>		---	2.7	---	
Input Capacitance	C <sub>iss</sub>	V <sub>DS</sub> =50V,V <sub>GS</sub> =0V,f=1MHZ	---	206	---	pF
Output Capacitance	C <sub>oss</sub>		---	29	---	
Reverse Transfer Capacitance	C <sub>rss</sub>		---	1.4	---	
<b>Drain-Source Body Diode Characteristics</b>						
Continuous Source Current	I <sub>s</sub>	VG=VD=0V , Force Current	---	---	5	A
Diode Forward Voltage	V <sub>SD</sub>	V <sub>GS</sub> =0V , IS=3A , TJ=25°C	---	---	1.2	V



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## Typical Characteristics

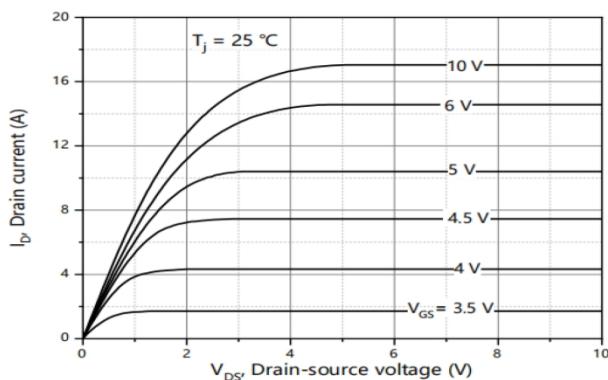


Figure1. Output Characteristics

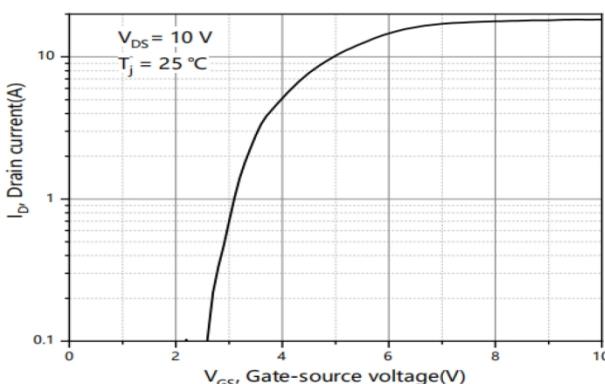


Figure2. Transfer Characteristics

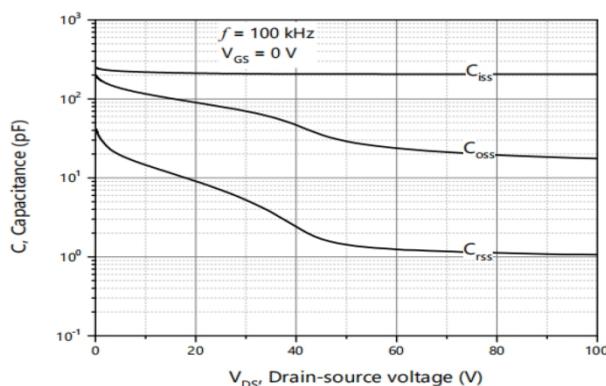


Figure3. Capacitance Characteristics

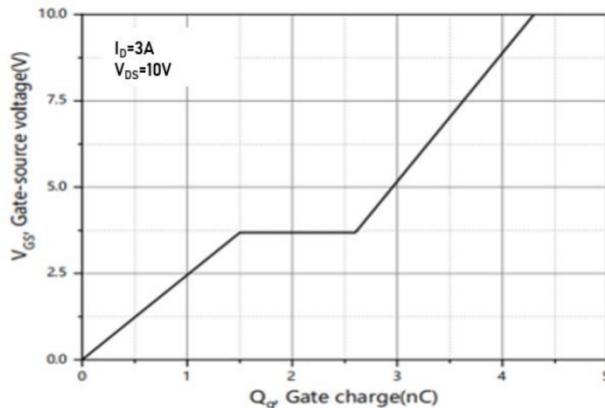


Figure4. Gate Charge

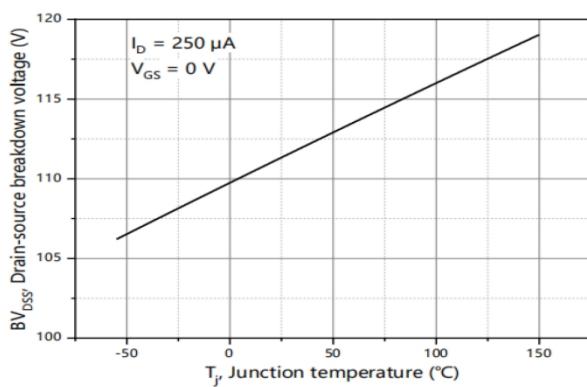


Figure5. Drain-Source breakdown voltage

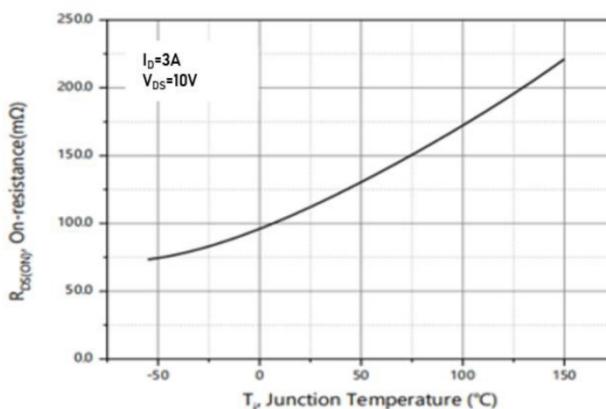


Figure6. Drain-Source on Resistance

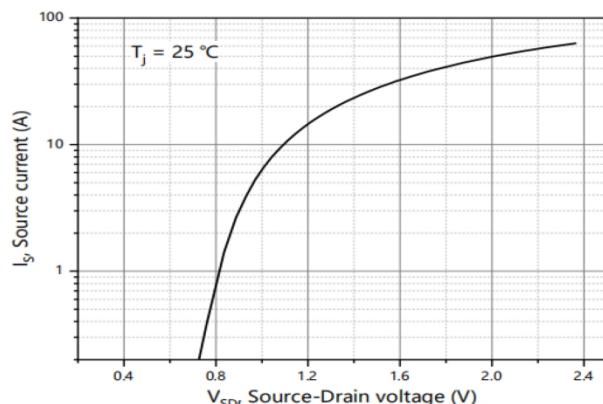


Figure7. Forward characteristic of body diode

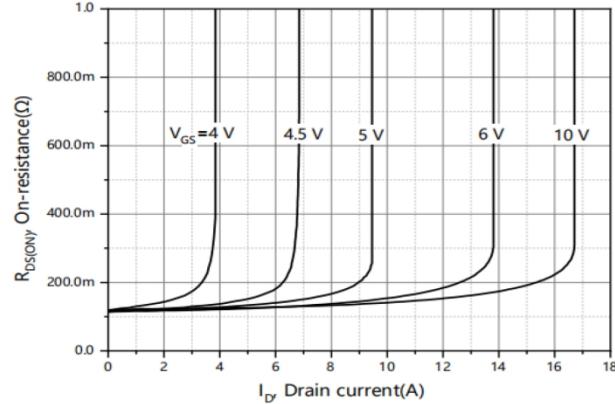


Figure8. Drain-source on-state resistance



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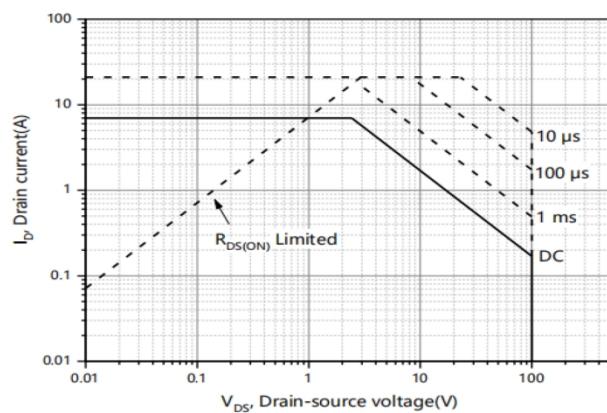


Figure9. Safe Operation Area  $T_A=25\text{ }^{\circ}\text{C}$

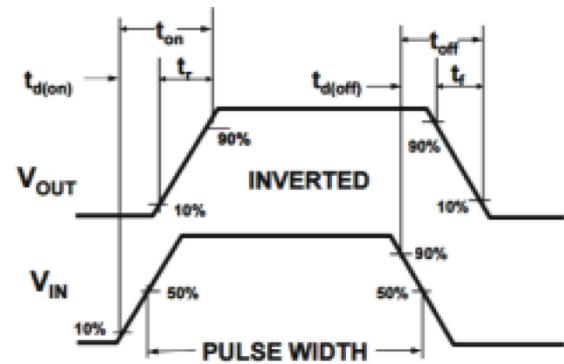


Figure10. Switching wave



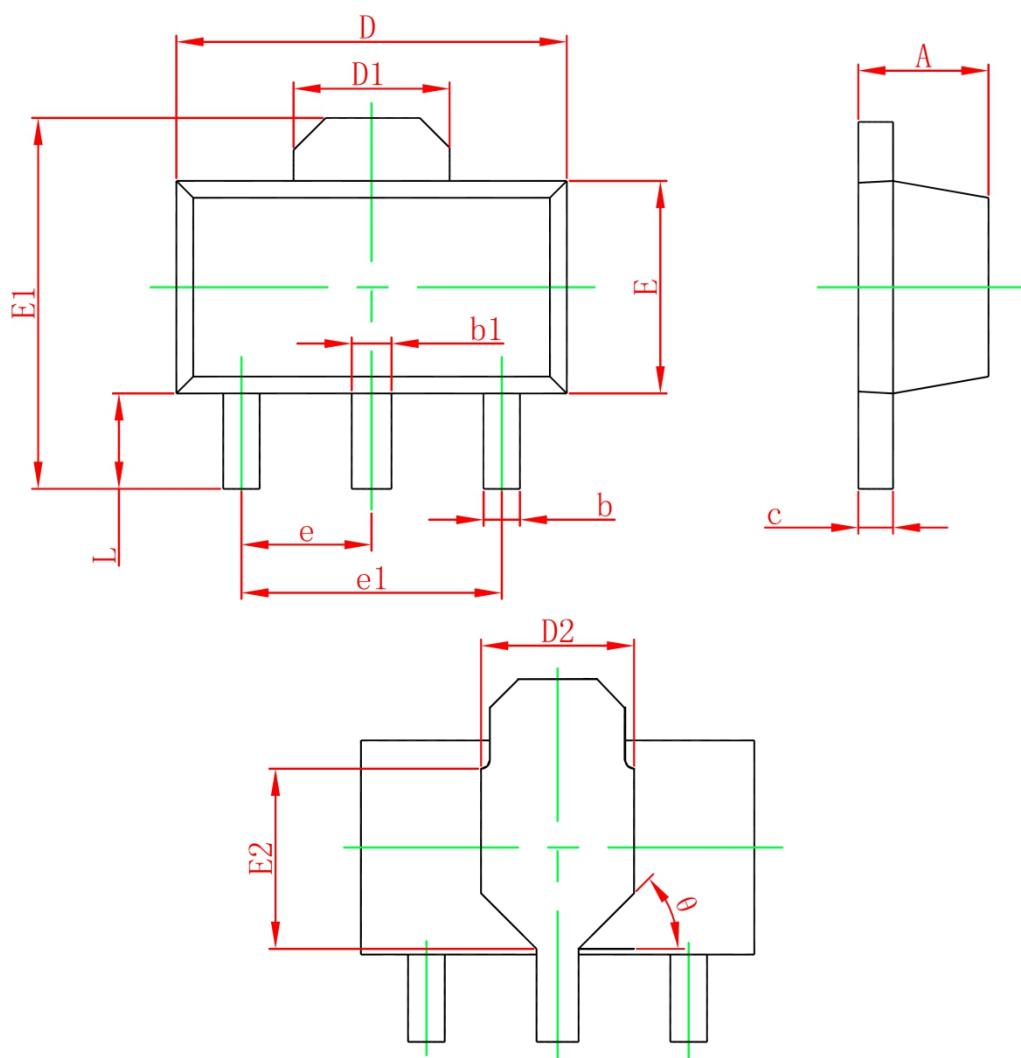
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SOT-89-3L Package Outline



Symbol	Dimensions In Millimeters	
	Min.	Max.
A	1.400	1.600
b	0.320	0.520
b1	0.400	0.580
c	0.350	0.440
D	4.400	4.600
D1	1.550 REF.	
D2	1.750 REF.	
E	2.300	2.600
E1	3.940	4.250
E2	1.900 REF.	
e	1.500 TYP.	
e1	3.000 TYP.	
L	0.900	1.200
θ	45°	